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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Date : 3/28/2005
IN RE APPLICATION OF : Yeu Wen Lee et al.
APPLN. NO. : 10/603257
FILED : 6/26/2003
FOR : METHOD FOR MAKING A DIRECT CHIP ATTACH DEVICE AND STRUCTURE
EXAMINER :
Phone :
Group : 1732

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING FACSIMILE TRANSMITTED TO
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SIGNATURE

STATUS INQUIRY

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

SIR:

Applicant(s) respectfully inquire as to the status of the above-identified patent application. The last communication was:

FILE RECEIPT dated 11/5/2003 and NOTICE OF PUBLICATION OF APPLICATION for publication on 12/30/2004.

Please advise us of the current status of this application.

Respectfully submitted,
Yeu Wen Lee



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